HIGH-VOLTAGE HIGH-CURRENT DARLINGTON TRANSISTOR ARRAYS

- 500-mA Rated Collector Current (Single Output)
- High-Voltage Outputs . . . 50 V
- Output Clamp Diodes
- Inputs Compatible With Various Types of Logic
- Relay Driver Applications
- Designed to Be Interchangeable With Sprague ULN2001A Series

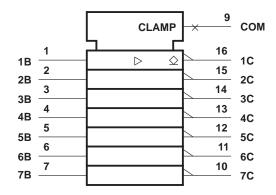
DOR N PACKAGE (TOP VIEW) 16 T 1C 1_B 15 12C 2В [2 3 14 3C 3B [13**∏** 4C 4B [12 **∏** 5C 5 5B 11 1 6C 6B 6 7B [7 10 7C 9∏ сом 8 F

description

The ULN2001A, ULN2002A, ULN2003A, and ULN2004A are monolithic high-voltage, high-current Darlington transistor arrays. Each consists of seven npn Darlington pairs that feature high-voltage outputs with common-cathode clamp diodes for switching inductive loads. The collector-current rating of a single Darlington pair is 500 mA. The Darlington pairs may be paralleled for higher current capability. Applications include relay drivers, hammer drivers, lamp drivers, display drivers (LED and gas discharge), line drivers, and logic buffers. For 100-V (otherwise interchangeable) versions, see the SN75465 through SN75469.

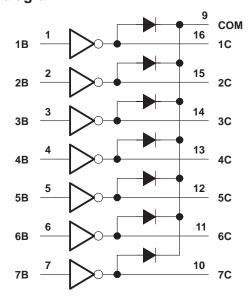
The ULN2001A is a general-purpose array and can be used with TTL and CMOS technologies. The ULN2002A is specifically designed for use with 14- to 25-V PMOS devices. Each input of this device has a zener diode and resistor in series to control the input current to a safe limit. The ULN2003A has a 2.7-k Ω series base resistor for each Darlington pair for operation directly with TTL or 5-V CMOS devices. The ULN2004A has a 10.5-k Ω series base resistor to allow its operation directly from CMOS devices that use supply voltages of 6 to 15 V. The required input current of the ULN2004A is below that of the ULN2003A, and the required voltage is less than that required by the ULN2002A.

logic symbol†



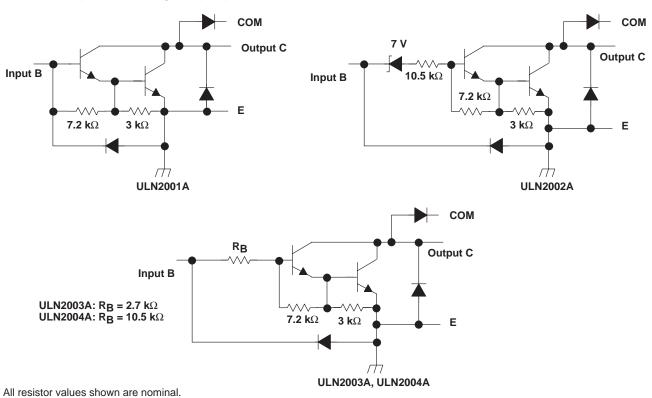
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram



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schematics (each Darlington pair)



absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

| Collector-emitter voltage | 50 V |
|--|------------------------------|
| Input voltage, V _I (see Note 1) | |
| Peak collector current (see Figures 14 and 15) | |
| Output clamp current, IOK | 500 mA |
| Total emitter-terminal current | –2.5 A |
| Continuous total power dissipation | See Dissipation Rating Table |
| Operating free-air temperature range, T _A | –20°C to 85°C |
| Storage temperature range, T _{stq} | 65°C to 150°C |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C |

NOTE 1: All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.

DISSIPATION RATING TABLE

| PACKAGE | T _A = 25°C POWER RATING | DERATING FACTOR ABOVE T _A = 25°C | T _A = 85°C POWER RATING | | | |
|---------|---------------------------------------|--|---------------------------------------|--|--|--|
| D | 950 mW | 7.6 mW/°C | 494 mW | | | |
| N | 1150 mW | 9.2 mW/°C | 598 mW | | | |



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electrical characteristics, $T_A = 25^{\circ}C$ (unless otherwise noted)

| | PARAMETER | TEST | I TEST CONDITIONS F | | ULN2001A | | | ULN2002A | | | UNIT | | | |
|--------------------|---------------------------------------|--------|--|-------------------------|----------|-----|-----------------------|----------|------|------|------|--|--|----|
| | PARAMETER | FIGURE | | | MIN | TYP | MAX | MIN | TYP | MAX | UNII | | | |
| V _{I(on)} | On-state input voltage | 6 | V _{CE} = 2 V, | $I_C = 300 \text{ mA}$ | | | | | | 13 | V | | | |
| | Collector-emitter saturation voltage | 5 | $I_I = 250 \mu A$, | $I_C = 100 \text{ mA}$ | | 0.9 | 1.1 | | 0.9 | 1.1 | | | | |
| VCE(sat) | | | $I_I = 350 \mu A$, | $I_C = 200 \text{ mA}$ | | 1 | 1.3 | | 1 | 1.3 | V | | | |
| | | | $I_I = 500 \mu A$, | $I_C = 350 \text{ mA}$ | | 1.2 | 1.6 | | 1.2 | 1.6 | | | | |
| ٧F | Clamp forward voltage | 8 | $I_F = 350 \text{ mA}$ | | | 1.7 | 2 | | 1.7 | 2 | V | | | |
| | Collector cutoff current | 1 | V _{CE} = 50 V, | I _I = 0 | | | 50 | | | 50 | | | | |
| ICEX | | 2 | V _{CE} = 50 V, T _A = 70°C | I _I = 0 | | | 100 | | | 100 | μΑ | | | |
| | | | | V _I = 6 V | | | | | | 500 | | | | |
| I(off) | Off-state input current | 3 | V _{CE} = 50 V, T _A = 70°C | $I_C = 500 \mu A$, | 50 | 65 | | 50 | 65 | | μΑ | | | |
| II | Input current | 4 | V _I = 17 V | | | | | | 0.82 | 1.25 | mA | | | |
| in. | Clamp revenue everent | 7 | $V_R = 50 V$, | TA = 70°C | | | 100 | | | 100 | | | | |
| ^I R | Clamp reverse current | | ' | / | ' | / | V _R = 50 V | | | | 50 | | | 50 |
| h _{FE} | Static forward current transfer ratio | 5 | V _{CE} = 2 V, | I _C = 350 mA | 1000 | | · | | | · | | | | |
| Ci | Input capacitance | | $V_{I} = 0,$ | f = 1 MHz | | 15 | 25 | | 15 | 25 | pF | | | |

electrical characteristics, $T_A = 25^{\circ}C$ (unless otherwise noted)

| | DADAMETED | TEST | TEST CONDITIONS | | ULN2003A | | | ULN2004A | | | | |
|---------------------|--------------------------------------|------|--|-------------------------|----------|------|------|----------|------|------|------|--|
| | PARAMETER | | TEST CONDITIONS | | MIN | TYP | MAX | MIN | TYP | MAX | UNIT | |
| | On-state input voltage | 6 | V 0V | I _C = 125 mA | | | | | | 5 | V | |
| | | | | I _C = 200 mA | | | 2.4 | | | 6 | | |
| V., . | | | | I _C = 250 mA | | | 2.7 | | | | | |
| V _I (on) | | | V _{CE} = 2 V | $I_C = 275 \text{ mA}$ | | | | | | 7 | | |
| | | | | $I_C = 300 \text{ mA}$ | | | 3 | | | | | |
| | | | | $I_C = 350 \text{ mA}$ | | | | | | 8 | | |
| | Collector-emitter saturation voltage | 5 | $I_I = 250 \mu A$, | $I_C = 100 \text{ mA}$ | | 0.9 | 1.1 | | 0.9 | 1.1 | V | |
| VCE(sat) | | | $I_I = 350 \mu A$, | I _C = 200 mA | | 1 | 1.3 | | 1 | 1.3 | | |
| | | | $I_{I} = 500 \mu A$, | $I_C = 350 \text{ mA}$ | | 1.2 | 1.6 | | 1.2 | 1.6 | | |
| I _{CEX} | Collector cutoff current | 1 | V _{CE} = 50 V, | I _I = 0 | | | 50 | | | 50 | μΑ | |
| | | 2 | VCE = 50 V, T _A = 70°C | I _I = 0 | | | 100 | | | 100 | | |
| | | | | V _I = 1 V | | | | | | 500 | | |
| ٧F | Clamp forward voltage | 8 | $I_F = 350 \text{ mA}$ | | | 1.7 | 2 | | 1.7 | 2 | V | |
| I(off) | Off-state input current | 3 | V _{CE} = 50 V, T _A = 70°C | $I_C = 500 \mu A$, | 50 | 65 | | 50 | 65 | | μΑ | |
| lį | Input current | 4 | V _I = 3.85 V | | | 0.93 | 1.35 | | | | | |
| | | | V _I = 5 V | | | | | | 0.35 | 0.5 | mA | |
| | | | V _I = 12 V | | | | | | 1 | 1.45 | | |
| I _R | Clamp reverse current | 7 | V _R = 50 V | | | | 50 | | | 50 | | |
| | | | $V_R = 50 V$, | T _A = 70°C | | | 100 | | | 100 | μΑ | |
| Ci | Input capacitance | | $V_{I} = 0,$ | f = 1 MHz | | 15 | 25 | | 15 | 25 | pF | |

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switching characteristics, T_A = 25°C

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------|--|--|--------------------|------|-----|------|
| tPLH | Propagation delay time, low-to-high-level output | See Figure 9 | | 0.25 | 1 | μs |
| tPHL | Propagation delay time, high-to-low-level output | See Figure 9 | | 0.25 | 1 | μs |
| Vон | High-level output voltage after switching | $V_S = 50 \text{ V}, \qquad I_O \approx 300 \text{ mA},$ See Figure 10 | V _S -20 | | | mV |

PARAMETER MEASUREMENT INFORMATION

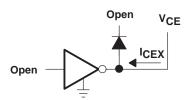


Figure 1. I_{CEX} Test Circuit

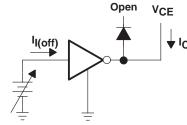
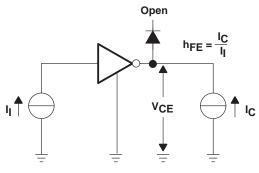


Figure 3. I_{I(off)} Test Circuit



NOTE: I_I is fixed for measuring $V_{CE(sat)}$, variable for measuring h_{FE}.

Figure 5. h_{FE}, V_{CE(sat)} Test Circuit

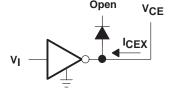


Figure 2. I_{CEX} Test Circuit

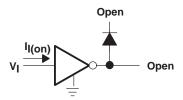


Figure 4. I_I Test Circuit

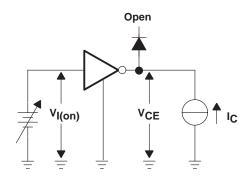


Figure 6. V_{I(on)} Test Circuit

PARAMETER MEASUREMENT INFORMATION



Figure 7. I_R Test Circuit

Figure 8. V_F Test Circuit

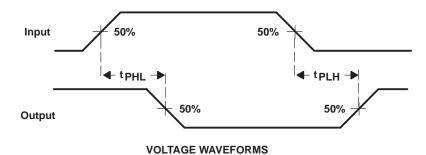
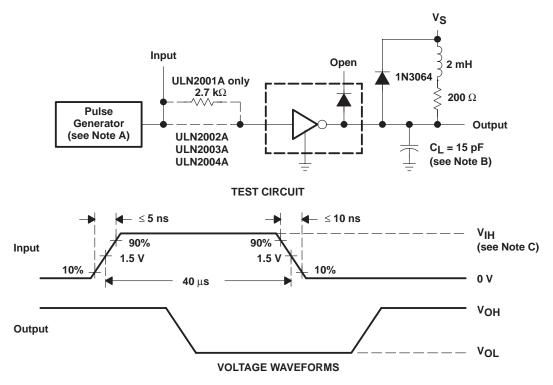


Figure 9. Propagation Delay Time Waveforms



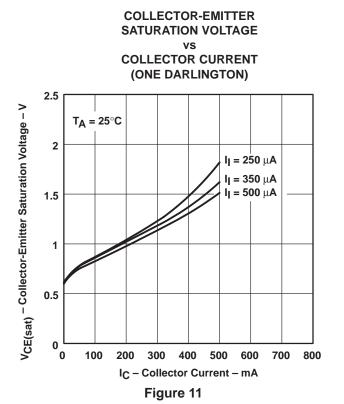
NOTES: A. The pulse generator has the following characteristics: PRR = 12.5 kHz, Z_0 = 50 Ω .

- B. C_L includes probe and jig capacitance.
- C. For testing the ULN2001A and the ULN2003A, V_{IH} = 3 V; for the ULN2002A, V_{IH} = 13 V; for the ULN2004A, V_{IH} = 8 V.

Figure 10. Latch-Up Test Circuit and Voltage Waveforms



TYPICAL CHARACTERISTICS



COLLECTOR-EMITTER SATURATION VOLTAGE vs TOTAL COLLECTOR CURRENT (TWO DARLINGTONS PARALLELED)

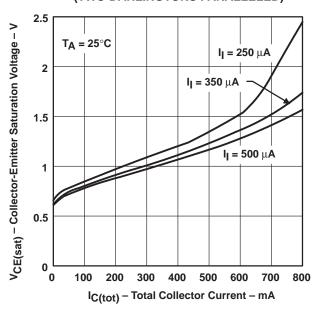


Figure 12

COLLECTOR CURRENT

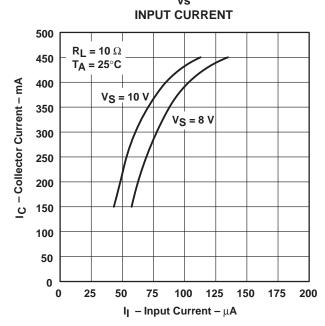


Figure 13



THERMAL INFORMATION

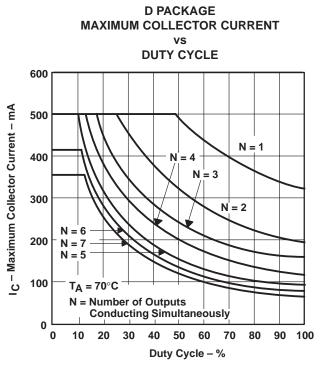


Figure 14

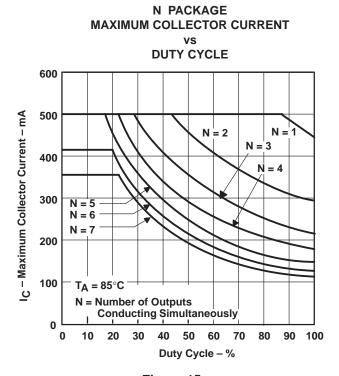


Figure 15

APPLICATION INFORMATION

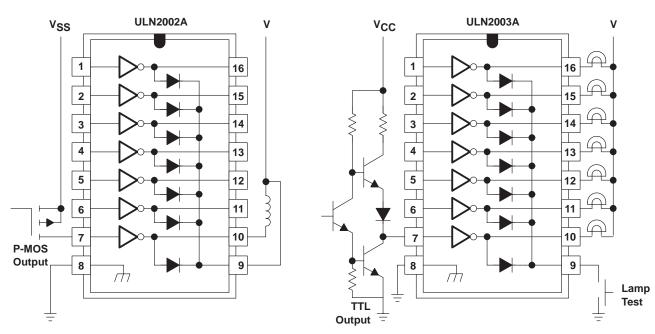


Figure 16. P-MOS to Load

Figure 17. TTL to Load

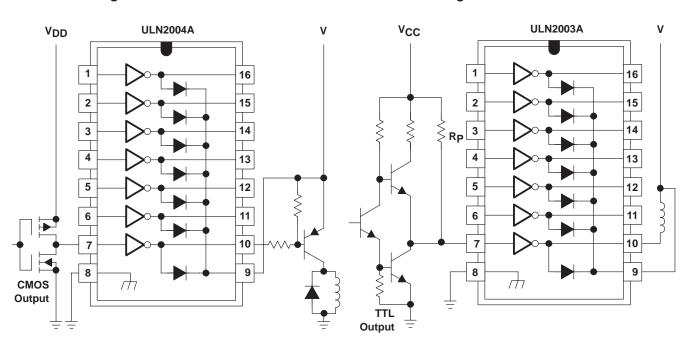


Figure 18. Buffer for Higher Current Loads

Figure 19. Use of Pullup Resistors to Increase Drive Current



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